



Date: 07/13/2022

ENV-00298 Rev G
Certificate of Compliance:
ISO 9001 Design, Marketing and Sales of Machine to Machine Connectivity Hardware and Software,
RoHS and REACH: SVHC

Lantronix Part Numbers:	Legacy Part Numbers:	Declared Product Weight:
A2200A	A2200-A-V9333	0.6 g / 0.02 oz.
A2235H	A2235-H-V9333	4.0 g / 0.14 oz.
A3100C(SWI-SG-F-36)		1.2 g / 0.04 oz.
A5100A	A5100-A-V521	1.2 g / 0.04 oz.
A5135H	A5135-H-V577	4 g / 0.14 oz.
60207	60207	According to configuration
60208	60208	According to configuration
60210	60210	NA
B41H00FS	BOLERO41	
B43H002S	BOLERO43#02	
B43H007S	BOLERO43#05	
B43H001S	BOLERO43#D	
B45H00FS	BOLERO45	
B41H00FB02	60254	
B45H00FB02	60255	
E214F002S	E214#02	
E214F00CS	E214#078	
E214F003S	E214#358S#158	
E214G000S	E214G#00	
E214G001S	E214G#01	
E215F002S	E215#02	
E218F004S	E218#04	
E218F009S	E218#1357	
E218F006S	E218#1BI	
E218F005S	E218#1JL	
MF13	E214, E218 accessory bundle	
MF14	E214G, E218G accessory bundle	
E224HPL3S	E224#358S#158	
E224HPL2S	E224#38K##38	
E225FLZ2S	E225LITE#02	
E225HPL2S	E225#02	
E228HPL6S	E228#1BI	
E228HPL5S	E228#1JL	
E228HPLAS	E228#245DH#25	
E228HPL3S	E228#37S	
E228G002S	E228GMKII#02	
E228G004S	E228GMKII#04	
E228G00CS	E228GMKII#078	
MF15	E225 Lite accessory bundle	
MF16	E225G Mk II, E225 accessory bundle	
MF17	E228G Mk II, E224, E228 accessory bundle	
F38H002S	60192	
F35HGZFS	60197	
F35H00FS	60198	
F35HH0FS	60209	
F38H000S	60233	
F35R00FS	60287	
F31H00FS	60307	



F33H00FS	60354
F35H01FS	60383
F33H002S	60467
F35H01FB02	60132
F35HGZFB02	60230
F38H005B02	60231
F35HH0FB02	60250
F35R00FB02	60251
F38H000B02	60252
F38H002B02	60253
B41H00FB02	60254
B45H00FB02	60255
F35H02FS	60284
F35H00FB02	60339
F33H002B02	60412
S47017S	S47-SPC-07
M111F00FS	M111
M113F00FS	M113-N
M114F005S	M114#1J
M114F002S	M114#37K##38
M114F000S	
MF18	M111-M113-M115 accessory bundle
MF19	M114 accessory bundle
60036	60036
60037	60037
60039	60039
60044	60044
60048	60048
60074	60074
60140	60140
60168	60168
P22E0	ACC-PS20
P24E0	ACC-PS20-F
A21H0	ACC-A21
A22H0	ACC-A22
A32H0	ACC-A32H
BR551	ACC-DIN-2M
KDC42	ACC-CA10
KEECO	ACC-CA29
60050	60050
60070	60070

The above-captioned products (the “Products”) are manufactured by an ISO 9001 certificated supplier. The Products conform to the specifications in the applicable Lantronix Data Sheet for each of these part numbers.

Lantronix, Inc. (“Lantronix”) is committed to marketing environmentally friendly products. Lantronix expects its contract manufacturers and their suppliers to ensure that material, components and processes comply with the appropriate directive regarding usage of hazardous substances. To the best of Lantronix’s knowledge, all materials, components and processes used in the manufacture of the Product are in compliance with the following:

- 1) 2011/65/EU Restriction of the use of Hazardous Substances in EEE (RoHS)
- 2) 2015/863/EU Change of Annex II from 2011/65/EU
- 3) Exemptions listed in the Annex III (Directive 2018/741/EU4 & 2018/736/EU6)

- 4) REACH: REGULATION (EC) No 1907/2006
- 5) The above-captioned products (the "Products") do not contain more than 0.1 % of product weight for each of 224 substances which are announced by ECHA as "Substances of Very High Concern (SVHC)". SVHC is defined in Article 59(10) of REACH regulations, based on the most recent substances. [224 Substances, last update: Jun 10, 2022] (Reference URL: <http://echa.europa.eu/web/guest/candidate-list-table>)
- 6) With regard to the requirement of Article 67 of REACH : A substance on its own, in a preparation or in an article, for which Annex XVII, contains a restriction shall not be manufactured, placed on the market or used unless it complies with the conditions of that restriction. We declare that none of the substances in the Conditions of restriction is present in Lantronix's products (and also package).
- 7) In addition of SVHC substances into Annex XIV, the addition of restricted substances in Annex XVII, Lantronix will evaluate the further revise in time and update this declaration to reflect these changes.
- 8) Chip Resistor that contains Lead oxide - PbO (CAS No. 1317-36-8) in raw materials, after a high-temperature process PbO and multiple constituents merge will transfer to glass, which is out of SVHC scope. Please refer to the JEITA's explanation.



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Worldwide Supplier Quality
Lantronix, Inc.